

MPVM07N60 Intelligent Power Module

Features

- Integrated 6 fast recovery power MOSFETs (600V/7A)
- Integrated high voltage gate drive circuit (HVIC)
- Compatible with 3.3V & 5V input signal, effective at high level
- Insulation class 1500Vrms / min
- Integrated bootstrap functionality
- High reliability and thermal stability, good parameter consistency
- Integrated temperature output

Applications

- Frequency conversion fans
- Cooker hood
- Air conditioning compressor
- Dish washer
- Air cleaner





SOP-23H

Product Name Marking Package Type MPVM07N60TA MPVM07N60TA DIP-23H MPVM07N60TD MPVM07N60TD SOP-23H

Internal Electrical Schematic



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
DC link supply voltage of P-N	V _{PN}	600	V
Single MOSFET output current, T_{C} =25 $^{\circ}C$	I _{D25}	7.0	٨
Single MOSFET output current, T_{C} =80 $^{\circ}C$	I _{D80}	5.0	A
Single MOSFET peak output current $T_C {=} 25^\circ\!\mathrm{C}$, pulse width ${<} 100\mu\text{s}$	I _{DP}	11	А
Power dissipation per MOSFET, T_c=25 $^\circ\!\!\mathrm{C}$	PD	15.2	W
Module supply voltage	V _{CC}	25	V
High side floating supply voltage (V_B reference to V_S)	V _{BS}	20	V
Input voltage	V _{IN}	-0.3~VCC+0.3	V
Operating junction temperature	ΤJ	-55 to 150	ر ا
Operating case temperature, TJ≤150°C	T _C	-55 to 150	C
Storage temperature range	T _{STG}	-55 to 150	°C
Single MOSFET thermal resistance, junction-case	Rejc	8.2	°C/W
Isolation test voltage (1min, RMS, f = 60Hz)	V _{ISO}	1500	Vrms
Bootstrap diode forward current, $T_C=25^{\circ}C$	IF	1	А
Bootstrap diode peak forward current, $T_C {=} 25^\circ\! {\mathbb C},$ pulse width =1ms	IFP	3	А

Recommended Operation Conditions

Deremeter	Symbol		Unit		
Farameter	Symbol	Min.	Тур.	Max.	Unit
DC link supply voltage of P-N	V _{PN}	-	300-	400	V
Low side supply voltage	V _{CC}	13.5	15	16.5	V
High side floating supply voltage	V _{BS}	13.5	15	16.5	V
Logic "1" input voltage (LIN, HIN)	VIN(ON)	2.5	-	-	V
Logic "0" input voltage (LIN, HIN)	VIN(OFF)	-	-	0.8	V
External deadtime between HIN and LIN	Tdead	-	540	-	ns
PWM switching frequency,Tյ≤150ºC	fPWM	-	16	-	KHz

Electrical Characteristics (unless otherwise noted, $T_j=25^{\circ}C$, $V_{CC}=V_{BS}=15V$)

Inverter Section

Deremeter	Symbol Condition		Value			l lucit
Parameter			Min.	Тур.	Max.	Unit
Drain-Source blocking voltage	B _{VDSS}	VIN=0V, I _D =250uA	600	-	-	V
Drain-Source leakage current	I _{DSS}	VDS=600V, VGS=0V	-	-	1	uA
Drain-Source on-state resistance	R _{DS(on)}	V _{GS} =10V, I _D =3.5A	-	1.1	1.3	Ω
Diode forward voltage	V _{SD}	V _{SG} =0V, I _s =3.5A	-	-	1.4	V
Switching time	t _{ON}			1080		ns
	t _{OFF}	VPN=300V,		660		ns
	t _{rr}	VCC=VBS=15V		88		ns
	E _{ON}	Inductive load		75		uJ
	E _{OFF}			7		uJ



Switching Time Definition

Control Section

Deremeter	Symbol Condition		Value			l lmit
Parameter			Min.	Тур.	Max.	Unit
Quiescent VCC supply current	lacc	VBIAS (VCC, VBS)	-	160	-	
Quiescent VB supply current	I _{QBS}	=15V T _A = 25°C	-	70	120	μA

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	VTO	V phase HVIC temperature @25℃		600	790	980	mV
Temperature output voltage	V13	V phase HVIC temperature @100°C		2.0	2.25	2.5	V
Low side undervoltage protection	UV_{CCR}	Reset level		8	8.9	9.8	V
High side undervoltage protection	UV_{BSR}	Reset level		8	8.9	9.8	V
Logic "1" input voltage (LIN, HIN)	VIH	Logic high level	Between	2.5	-	-	V
Logic "0" input voltage (LIN, HIN)	V _{IL}	Logic low level	COM	-	-	0.8	V
Input bias current for LIN, HIN	Iн	VIN=5V	Between	-	6	15	_
	IIL	VIN=0V	input and COM	-	-	1	μA

Bootstrap diode section

Doromotor	Symbol	wmhal		Value			
Farameter			Min.	Тур.	Max.	Omt	
Forward voltage	VF	I _F =10mA@ T _j =25℃	-	3.0	3.5	V	
		I _F =10mA@ T _j =125℃	-	-	3.0	V	
Reverse recovery time	t _{rr}	I _F =0.1A, V _R =30V, di _F /dt=-200A/μs	-	-	45	ns	

Pin Assignment



Pin Description

Pin Number	Pin name	I/O	Pin Description
1	СОМ	I/O	Module common ground
2	V _{BU}	I/O	U-phase high side floating IC supply voltage
3	V _{CCU}	I/O	U-phase low side driver supply voltage
4	I _{NUH}	Ι	U-phase high side gate driver input
5	I _{NUL}	Ι	U-phase low side gate driver input
6	NC	I/O	No Connection
7	V _{BV}	I/O	V-phase high side floating IC supply voltage
8	V _{CCV}	I/O	V-phase low side driver supply voltage
9	I _{NVH}	Ι	V-phase high side gate driver input
10	I _{NVL}	Ι	V-phase low side gate driver input
11	VTS	0	Temperature sensing output signal
12	V _{BW}	I/O	W-phase high side floating IC supply voltage
13	Vccw	I/O	W-phase low side driver supply voltage
14	I _{NWH}	Ι	W-phase high side gate driver input
15	I _{NWL}	Ι	W-phase low side gate driver input
16	NC	I/O	No Connection
17	Р	I/O	Positive bus input voltage
18	U,V _{SU}	0	Motor U-phase output and U-phase high side
			drive bias voltage ground
19	NU	I/O	U-phase low side source
20	NV	I/O	V-phase low side source
21	V,V _{SV}	0	Motor V-phase output and V-phase high side
			drive bias voltage ground
22	NW	I/O	W-phase low side source
23	W,Vsw	0	Motor W-phase output and W-phase high side
			drive bias voltage ground

Function description

Input-output table

INH	INL	OUTPUT	REMARK
0	0	Z	The high and low sides of the bridge arm are closed
0	1	0	The low side of the bridge arm is opened
1	0	VDC	The high side of the bridge arm is opened
1	1	Forbid	Bridge arm punch through
Open	Open	Z	The high and low sides of the bridge arm are closed



Control sequence diagram



Temperature Profile of V_{TS}(Typical)

I_D Drain Current vs. Case Temperature

Case temperature Tc detection



Typical Application Schematic:



Remark:

(1) The wiring of each input pin shall be as short as possible, otherwise it may cause mis operation; in addition, RC filter can be used to reduce input signal noise.

(2) All external capacitors should be located close to IPM.

(3) In order to prevent surge damage, in addition to filter capacitance between PN, it is recommended to add a high-frequency non inductive smoothing capacitance, and the connection of capacitance should be as short as possible.

(4) The filter capacitance at the input of VCC power supply is recommended to be at least 7 times of bootstrap capacitance C1.

(5) The bootstrap capacitor C1 is suggested to adopt a capacitor with high frequency characteristics to absorb high frequency ripple current, and its capacitance value is suggested to be greater than 2.2uf.

(6) The connection between current limiting resistor R4 and IPM shall be as short as possible to prevent the large surge voltage generated by the connection inductance from damaging IPM.

Package Outline DIP23



Package Outline SOP23



Disclaimer:

Operating conditions may differ from simulation assumptions in several aspects like level of DC-link voltage, applied gate-voltage and gate-resistor, case and junction temperatures as well as the power circuit stray-inductance. Therefore, deviations of parameters and assumptions used for the simulation and the real application may exist.

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